

Characterization of Nano-Oxide Layers Fabricated by Ion Beam Oxidation

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Abstract—In this paper, a remote O_2 ion source is used for the formation of nano-oxide layers. The oxidation efficiency was measured in CoFe-oxide films, and a decrease of the oxide layer with the pan angle and the oxidation pressure is observed. For the same oxidation pressure, the oxidation efficiency depends on the O_2 content in the Ar- O_2 plasma. These results were applied in optimizing the fabrication of Al_2O_3 barrier for tunnel junctions. This method was also used to fabricate junctions with Fe-oxide layers inserted at the Al_2O_3 -CoFe interface. TEM and magnetization data indicate that after anneal at $385^\circ C$, a homogeneous ferromagnetic Fe-oxide layer (Fe_3O_4 ?) is formed.

Index Terms—Ion oxidation, nano-oxide layers, transmission electron microscopy, tunnel junctions.

I. INTRODUCTION

THE fabrication of thin oxide layers ($< 20 \text{ \AA}$) is commonly done by oxidation of a metallic layer, using natural or plasma oxidation [1]. The control of the oxidation process and the smoothness of the metallic layer will determine the continuity and quality of the oxide layer. In particular, for a magnetic tunnel junction application, the oxide barrier and the interface with the electrodes are determinant for the device operation. Also, the use of spin valves at recording densities $> 100 \text{ Gbit/in}^2$ requires magnetoresistive signals that approach $\sim 20\%$, which can be obtained using specular spin valves, where nano-oxide layers are incorporated in the present state-of-the-art spin valves. The consequent increase of the sensor resistance becomes an advantage if a current-perpendicular-to-plane geometry is used.

The method for ion beam oxidation using remote plasma is described in this paper. Although the method has been used for tunnel junction fabrication for several years [2], this paper is focused on the characterization of the oxide layers formed by this

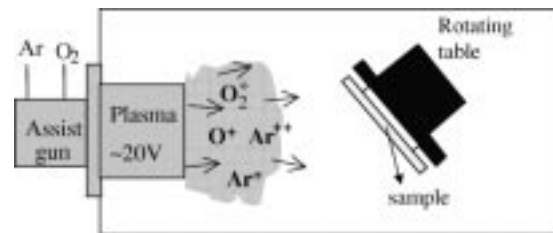


Fig. 1. Oxidation using a remote plasma created inside the assist source. Ar is required for plasma stabilization. The ions reach the sample surface without any voltage applied to the assist gun grids.

method. A particular application is shown for tunnel junctions fabricated with two nano-oxide layers: the Al_2O_3 barrier and a Fe-oxide layer inserted between the Al_2O_3 barrier and the top electrode [3]. With this FeOx layer, 40% tunnel magnetoresistance (TMR) is obtained upon anneal at $380^\circ C$. This structure maintains TMR values of 20% after 10-h anneal at $380^\circ C$.

II. EXPERIMENT

The structures studied were deposited using an automated Nordiko N3000 ion beam system [2] with a base pressure of 5×10^{-8} torr. The depositions were done at 3.5×10^{-5} torr, using an Xe beam (33 mA) formed by extracting the ions with 1750 V (acceleration = +1450 V, deceleration = -300 V) from an RF plasma created inside a 10-cm diameter ion source. The oxidation (Fig. 1) was carried out by the ions from an Ar- O_2 plasma (2.24 kW/m^2) created inside the 25-cm diameter assist source (Ar is needed for plasma stabilization). The pressure was varied from 3.2×10^{-5} to 2.4×10^{-4} torr and was determined by the flow of Ar and O_2 , which was tuned from 4–16 sccm (Ar) and 1.5–40 sccm (O_2). For the samples studied in this paper, the oxidizing ions are not extracted ($V^+ = V^- = 0 \text{ V}$), reaching the sample with the thermal energy of $\sim 20 \text{ eV}$. Both for the deposition and oxidation, the table rotates at 15 rpm, and the table was tilted from 25° to 80° relatively to the loading direction.

The standard tunnel junctions described in this paper have the structure (thickness in angstroms): Ta 90/Ni₈₀Fe₂₀ 70/Co₈₂Fe₁₈ 30/Al 9 + 10-s oxidation/Co₈₂Fe₁₈ 40/Mn₇₄Ir₂₆ 250/Ta 30, and were patterned by photolithography down to $2 \times 1 \text{ }\mu\text{m}^2$, using a self-aligned process.

III. OXIDE LAYER CHARACTERIZATION

A. CoFe-Oxide Nanolayers

Samples with the structure Si/ Al_2O_3 600 \AA /Ta 50/CoFe 100/oxidation/CoFe 100/Ta 50 (thickness in \AA) were analyzed

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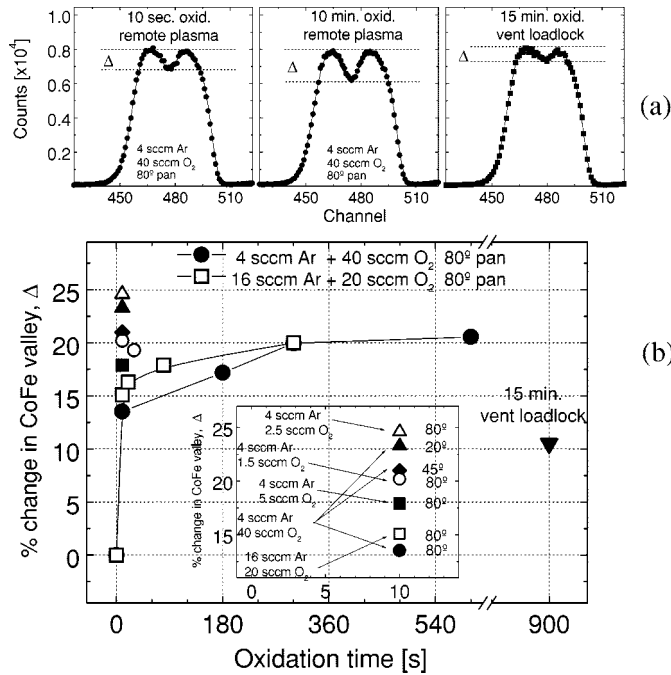


Fig. 2. (a) RBS spectra of the structure. Ta 50 Å/CoFe 100 Å/oxidation/CoFe 100 Å/Ta 50 Å. (b) Oxidation efficiency as a function of the oxidation time. The inset shows a detail for 10-s oxidation.

using the Rutherford Backscattering Spectroscopy (RBS) technique, without any prior thermal treatment. For reference, one sample was prepared by natural oxidation: the bottom CoFe film was exposed to atmosphere for 15 min [4] in a class 100 clean room environment (30% controlled humidity, 20 °C). The RBS experiments were carried out with a 1.6-MeV He⁺ beam (collimated $0.2 \times 0.6 \text{ mm}^2$ beam) in grazing angle incidence (77° tilt), and the backscattering angle was 160° in Cornell geometry. Information on the relative thickness of the oxide layers can be obtained directly from the experimental RBS spectra: without any oxidation, the RBS spectrum shows a single broad peak at the Co and Fe region (the width of the peak corresponding to the thickness of the two CoFe layers). When the bottom CoFe layer is oxidized (Fig. 2), the Co and Fe elements distribution in depth will change from a bulk layer to a mixed Co, Fe, and O layer, where the CoFe amount at a certain depth is reduced due to the presence of oxygen atoms. Consequently, the RBS spectra shows a valley between both CoFe layers, whose depth is proportional to the oxygen incorporated at the CoFeO layer. In Fig. 2(b), the percentage change Δ in the CoFe valley is used to compare samples with different oxidation conditions. The inset shows results on samples oxidized for 10 s under different oxidation conditions. This time was chosen because it is the required for complete oxidation of the 9-Å-thick Al layer in the tunnel junction structures. Fig. 3 summarizes the oxidation (Δ) dependence on pan angle, oxidation pressure, and O₂-Ar content during the oxidation. Lower pan angles (20° and 45°) were chosen to avoid the substrate to be directly exposed to the assist source. The results actually indicate larger oxygen incorporation, when compared with an 80° pan angle. This probably occurs because lower pan angles are associated with larger film exposed areas.

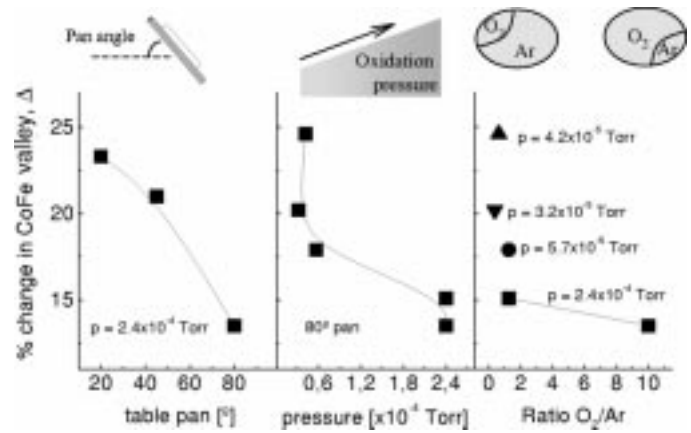


Fig. 3. Dependence of the CoFe valley depth on the oxidation conditions for 10-s oxidation.

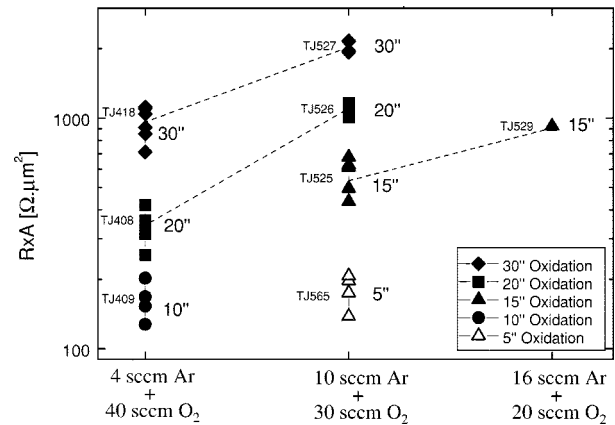


Fig. 4. Resistance-area products measured for junction devices fabricated with 9-Å-thick Al layers. The oxidation was done with different Ar-O₂ ratios, while maintaining the same pressure (2.4×10^{-4} torr) and pan angle (80°).

It is also found that Δ decreases with oxidation pressure (less oxygen arriving at the film surface due to the decreased mean-free path). Keeping the same oxidation pressure, the oxidation efficiency decreases when decreasing the Ar content in the Ar-O₂ mixture. This result requires further investigation.

With the RBS technique, the absolute thickness values could only be obtained if the CoFe-oxide density is known. Accurate values were obtained by X-rays, and the CoFe-oxide thickness was calibrated as 30 Å ($\Delta = 20\%$) and 15 Å ($\Delta = 10\%$) [4]. The nature of the oxide cannot be identified, but X-ray photon spectroscopy (XPS) indicated clearly the formation of Fe-oxide phases and not Co-oxide.

B. Al-Oxide Nanolayers in Tunnel Junctions

Although the oxidation rate is different for Co, Fe, and Al films, the information obtained from the experiment was used when optimizing the oxidation of 9-Å-thick Al layers in tunnel junction structures. Fig. 4 shows results from junctions fabricated with 10-s oxidation at 80° pan and 2.4×10^{-4} torr, using different Ar-O₂ ratios. TMR values of 20%–26% are obtained for the as-deposited junctions. The increase of the junction resistance with the reduction of the O₂ amount in the plasma is consistent with the increase of the CoFe valley depth plotted in

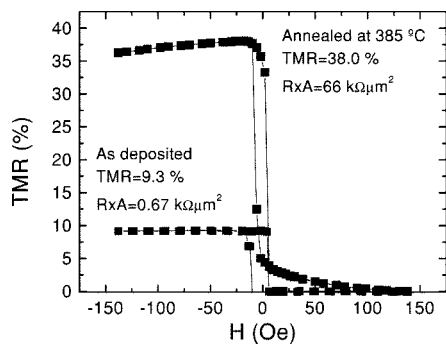


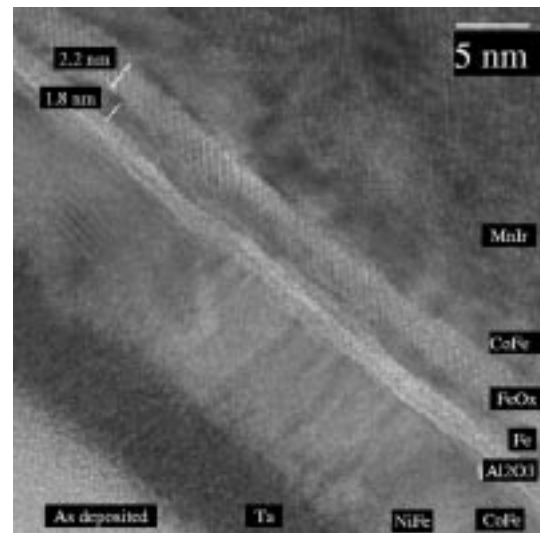
Fig. 5. Tunnel junction transfer curves as-deposited and after annealing at 385 °C (used with permission from [3]).

Fig. 3, indicating higher oxidation efficiency. After anneal (typically 1 h at 270 °C), oxygen migration from the partially oxidized interfacial CoFe into the barrier causes the TMR increase up to ~45%, with barrier heights >2 eV, breakdown voltages of ~1 V, bias voltages V_{half} of ~450 mV, and thermal stability up to 300 °C [5], which are good indicators of the high quality of the Al_2O_3 films. For thinner barriers, the bottom electrode roughness and the coverage of the CoFe layer by the ultrathin Al layer will determine the extension of the oxidation (partial oxidation of the bottom electrode will reduce the TMR), and in these cases, natural oxidation arises as a “softer” method for barrier fabrication [6].

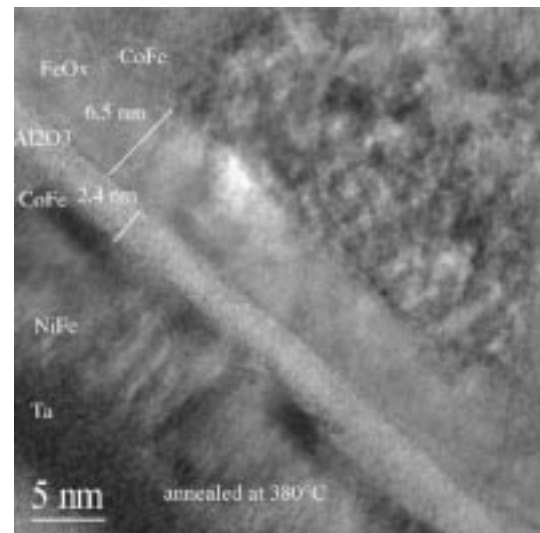
C. Fe-Oxide Nanolayers in Tunnel Junctions

So as to increase the TMR values or improve the thermal stability, junctions have been fabricated with an Fe-oxide layer inserted between the barrier and the pinned top CoFe layer [3]. The goal is the formation of a ferromagnetic, half-metallic Fe_3O_4 electrode, with 100% polarization. However, the formation of this phase requires high-temperature growth, and the oxidation at room temperature of an Fe layer produces paramagnetic or antiferromagnetic phases instead [3]. We found (Fig. 5) that standard top pinned junctions (described in Section II) with a 25-Å-thick Fe layer oxidized for 10 s by remote plasma (conditions are the same as for the optimized 9-Å Al-layer oxidation) inserted between the AlOx barrier and the top pinned CoFe layer show low TMR in the as-deposited state (9%) increasing sharply to ~40% after anneal at 380 °C [3].

TEM analysis (Fig. 6) shows that in the as-deposited state this oxidation method leads to ~18 Å of metallic Fe and ~22 Å of FeOx, with full oxidation of the Al layer (confirmed by XPS). The barrier is oxygen-deficient and becomes more stoichiometric upon anneal [7]. Magnetic measurements indicate that this “pure” Fe layer is paramagnetic. After annealing at 385 °C, the Fe layer becomes completely oxidized, with a 65-Å-thick homogeneous FeOx layer formed: Fe_3O_4 or Fe_2O_3 according to the interreticular spacing values of 0.29 and 0.25 nm. The magnetic nature of this Fe-oxide layer was investigated. Magnetization measurements of (Fe20-Å/10-s oxidation) multilayers showed an increase of the moment upon anneal, coming from the as-deposited nonmagnetic or paramagnetic FeOx decomposition into a ferromagnetic oxide, thus Fe_3O_4 .



(a)



(b)

Fig. 6. Cross section high-resolution TEM pictures of the tunnel junction stack (a) as deposited and (b) after annealing at 380 °C.

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